

L Number	Hits	Search Text	DB	Time stamp
1	4788	438/612,653-654,656.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/13 07:46
2	6941	257/766-772,750,751,753,762-764,774.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/13 07:46
3	11388	438/612,653-654,656.ccls. or 257/766-772,750,751,753,762-764,774.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/13 07:46
5	38	((438/612,653-654,656.ccls. or 257/766-772,750,751,753,762-764,774.ccls.) and (electroless with plat\$4 with (copper or cu))) and (solder adj bump)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/13 07:48
4	329	(438/612,653-654,656.ccls. or 257/766-772,750,751,753,762-764,774.ccls.) and (electroless with plat\$4 with (copper or cu))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/13 07:51